



25x32MM Daisy-Chain PBGA

FEATURES REPRESENTATIVE OF WEDC PBGAS:

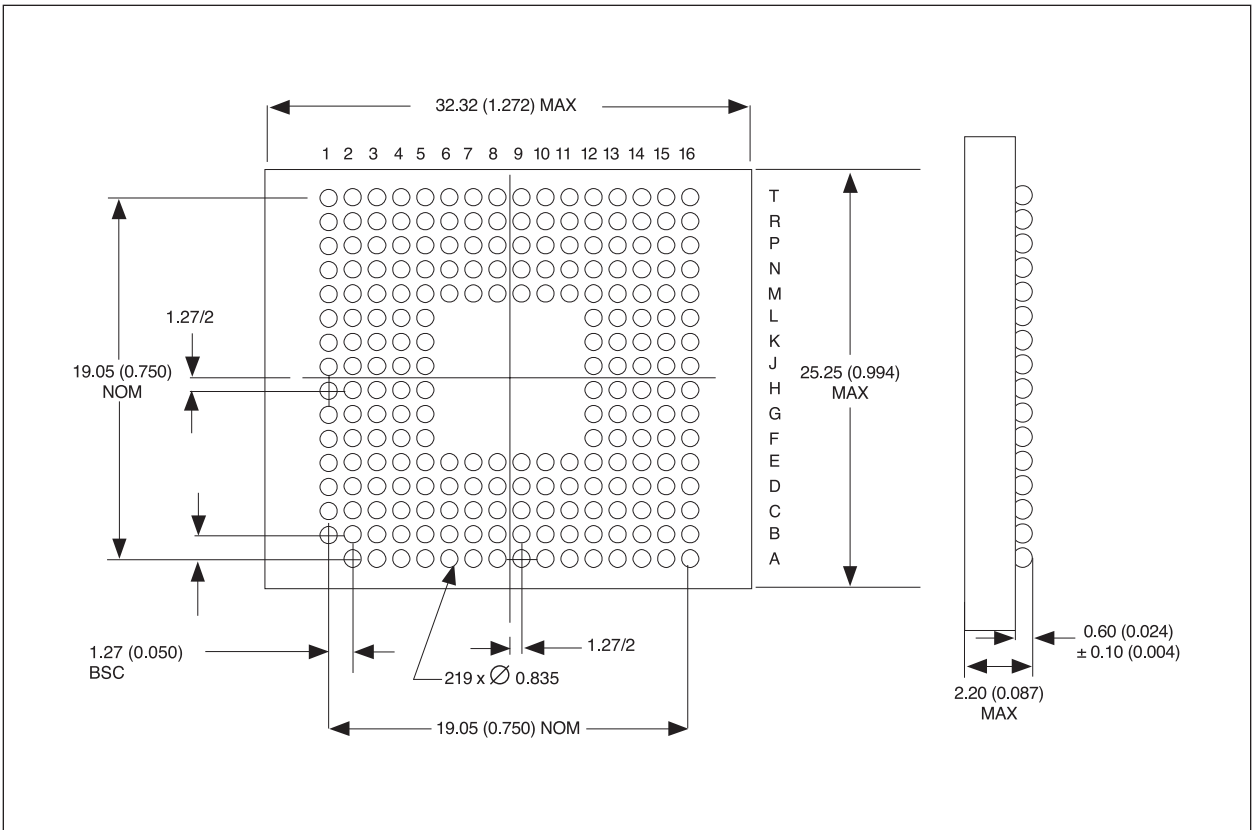
- 25 x 32mm, 25 x 25mm, 25 x 21mm, 21 x 21mm
- Package material and assembly process
- Ball pads diameter and ball attach process
- Substrate dimensions, material, process and thickness (no vias)
- Die dimensions and thickness (dummy die, no wirebonds) 3 - State Outputs

DESCRIPTION

This is a mechanical daisy-chain test vehicle designed to be representative of the 25 x 32mm, 25 x 25mm, 25 x 21mm, and 21 x 21mm packages. Use is for second level interconnection assembly test such temperature cycling, and continuity verification of the PBGA to the test board when it is overflowed.

This product is subject to change without notice.

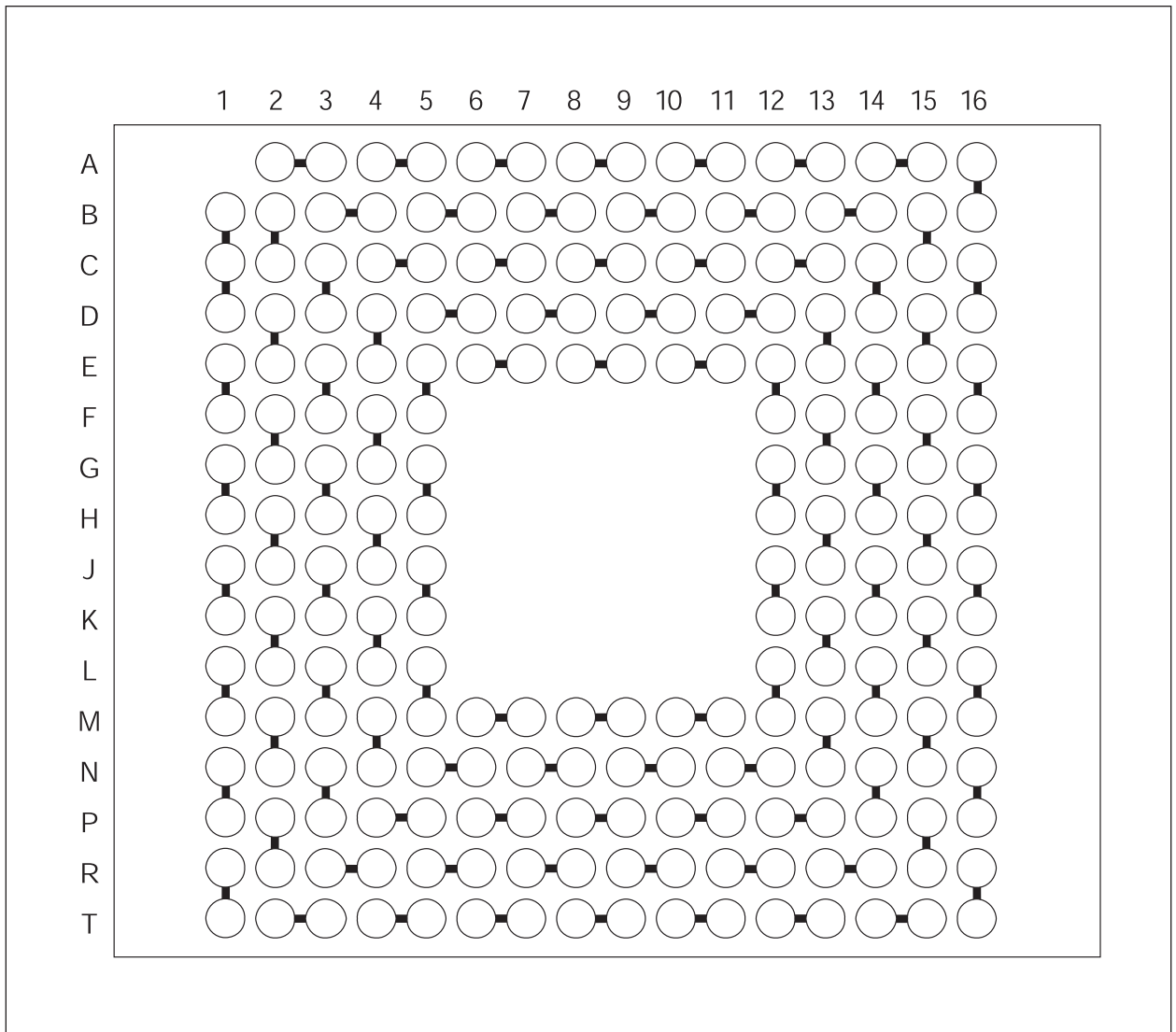
PACKAGE DIMENSION: 219 PLASTIC BALL GRID ARRAY (PBGA)



All linear dimensions are in millimeters and parenthetically in inches.



FIGURE 1 – DAISY-CHAIN INTERCONNECTION





ORDERING INFORMATION

WEP P DC 3225 B

PACKAGE:

B = 219 PBGA

PACKAGE DIMENSIONS:

3225 = 32mm x 25mm

TYPE:

DC = DAISY CHAIN

PLASTIC

WHITE ELECTRONIC DESIGNS CORP.